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Pulsed Electro-Acoustic (PEA) measurements of embedded charge distributions

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ABSTRACT

Knowledge of the spatial distribution and evolution of embedded charge in thin dielectric materials has important applications in semiconductor, high-power electronic device, high-voltage DC power cable insulation, high-energy and plasma physics apparatus, and spacecraft industries. Knowing how, where, and how much charge accumulates and how it redistributes and dissipates can predict destructive charging effects. Pulsed Electro-acoustic (PEA) measurements—and two closely related methods, Pressure Wave Propagation (PWP) and Laser Intensity Modulation (LIMM)—nondestructively probe such internal charge distributions. We review the instrumentation, methods, theory and signal processing of simple PEA experiments, as well as the related PPW and LIMM methods. We emphasize system improvements required to achieve high spatial resolution for \textit{in vacuo} measurements of thin dielectrics charged using electron beam injection.

\textbf{Keywords:} ultrasonics, charging, spacecharge, dielectrics, space environment, charge distributions, internal charging

1. INTRODUCTION

Knowledge of the spatial distribution and evolution of embedded charge in thin dielectric materials has important applications in semiconductor, high-power electronic device, and high-voltage DC power cable insulation industries\textsuperscript{1,2}. Other key applications—including high energy physics facilities and plasma chambers and spacecraft charging—expose dielectrics to charged-particle fluxes. Charge is introduced into dielectric through electron beam injection, and can accumulate in dielectric materials until potentials are high enough to initiate electrostatic discharge (ESD). In space environments, spacecraft are exposed to charged particle fluxes ranging from relatively low (<100eV) to high (>100keV) energies at typical current densities ranging from <0.1 pA/cm\textsuperscript{2} to >10 nA/cm\textsuperscript{2} (see Fig. 1)\textsuperscript{4}. Such spacecraft charging effects produce over half of the known spacecraft system anomalies—electron upsets, damage to components, power system debilities, and even complete satellite failures—that have been attributed to interactions with the natural space environment.\textsuperscript{3} As all of these applications proliferate—with the concomitant use of more advanced materials, more sensitive components, more severe environmental conditions, and more demanding objectives—the importance of understanding and minimizing dielectric charging will only become more important. In short, knowing how, where, and how much charge accumulates and how it redistributes and dissipates for given materials, configurations and environments is the key to prediction, avoidance and mitigation of these ubiquitous and destructive “arc and spark” effects.

The complex relationships between insulators and their surroundings are fundamentally based on a detailed knowledge of how individual materials store and transport charge\textsuperscript{3,5}. The accumulation and re-emission of charge, and the rate that energy is imparted to the material depend on the energy distribution and magnitude of incident fluxes, as well as energy loss mechanisms of the incident particles for a given material\textsuperscript{6}. The conductivity of high resistivity components (and its temperature dependence) is a key transport parameter to determine how the deposited charge will redistribute throughout a system, how rapidly charge imbalances will dissipate, and what equilibrium potential will be established under given environmental conditions\textsuperscript{7}. Thus, the electron emission and transport properties of materials are key parameters in determining the likelihood of deleterious charging effects.

However, while measurements of the electron emission and displacement currents, the evolving surface potential, and the electrostatic breakdown of materials exposed to particle fluxes have provided important information over the last five

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decades, the “holy grail” of materials characterization in dielectric charging is a nondestructive method to directly measure the magnitude and the spatial and temporal evolution of internal charge distributions on length and time scales appropriate to practical charging problems. Pulsed Electro-acoustic (PEA) measurements—and two closely related methods, Pressure Wave Propagation (PWP) and Laser Intensity Modulation (LIMM)—provide such methods.

2. COMPARISON OF METHODS

This paper provides an overview of these three methods, with an emphasis on use of these techniques for high spatial resolution in vacuo measurements of thin film polymeric, ceramic, or glass dielectric materials charged with medium to high energy (~10^3 eV to ~10^7 eV) electron beams. A description of each of these methods is summarized in Table 1, along with a list of their relative advantages and disadvantages. Conceptual instrument diagrams for the PEA, PWP, and LIMM methods configurations are shown in Figure 2. All three systems consist of a thin film sample bounded by two electrodes: (i) a probe electrode that introduces a high-frequency pulsed waveform (high-voltage electric field waveform for PEA, ultrasonic acoustic waveform for PWP, and optically-induced thermal acoustic waveform for LIMM) and (ii) a sensor electrode that measures an amplified high-frequency response signal (ultrasonic acoustic waveforms for PEA or displacement current waveforms for PWP and LIMM, converted to voltage signals and amplified). The primary instrumentation components for the three methods are identified in Table 2.

2.1 Design Criteria

We begin first by considering the general requirements for such a nondestructive method to measure the spatial and temporal evolution of internal charge distributions. The design criteria are established by charging applications, especially for electron flux charge deposition for spacecraft charging. What has been missing to date, particularly for the spacecraft charging community, is the resolution needed to measure charge distributions on a length scale typically encountered in real spacecraft charging situations. The required spatial resolution is set by requirements that either:

- For many common spacecraft applications a reasonable lower bound of thickness is set by thin thermal blankets, solar coverglasses, or thermal paints with thickness on the order of 0.5mil (~12µm) (See Table 3)
- The penetration depth for lower energy electrons that are most prevalent in space environment fluxes (~1 to 50 keV).
Referring to Table 3 and Figure 1, it is evident that spatial resolutions of 1 µm are required to satisfy both criteria (i) and (ii) to adequately resolve charge distributions for incident lower energy electrons with the highest fluxes for all but the thinnest spacecraft materials. Therefore, the targeted spatial resolution is specified at ≤ 1 µm (see Table 3).

The temporal resolution needed to acquire measurements is set by a reasonable fraction of:

- The time to acquire substantial charge in the space environment (~10³ to 10⁷ s or longer in typical space environments to acquire charge densities of magnitude ≤ 1 nC/cm² resulting in electric fields ≤ 10⁶ V/m for ~100 µm thick dielectric layers) or
- The time to dissipate charge through the material (~10⁰ to ~10⁴ s or higher; see Table 3), as limited by the conductivity of typical spacecraft dielectrics [~10⁻¹³ to 10⁻¹⁷ (Ω·cm)⁻¹].

Together, this suggests a range of 1 s to 10³ s time resolution. As noted below, existing PEA systems can routinely acquire data on time scales of <1 s, in special cases down to ~10 µs [10,16]. Therefore, the targeted temporal resolution is specified at ≤ 1 sec.

A reasonable target for charge sensitivity is ≤ 1 nC/cm², equal to 1% of breakdown field strength with charge layer near midpoint of thinnest (~10 µm) dielectric spacecraft films with a relative permittivity of ~ 2 (see Table 3). PEA apparatus are now routinely used to measures charge distributions of densities ≥100 nC/cm² or ~10¹² electrons/cm³ (that is, ≥0.1 nC/cm² for ~10 µm thick samples) [14,16].

A reasonable target for the maximum voltage applied across test samples is set by considering that:

- To avoid electrical breakdown across samples, the electric field should not exceed ~100 MV/m, or about ~1 kV across a 10 µm thick sample and ~100 kV across a 1 mm sample.

### Table 1. Relative advantages and disadvantages of charge density distribution measurement methods.

<table>
<thead>
<tr>
<th>Method</th>
<th>Description</th>
<th>Advantages</th>
<th>Disadvantages</th>
</tr>
</thead>
</table>
| PEA    | Pulsed Electro-acoustic⁹⁰ | • Nondestructive.  
• Low cost.  
• Simplified modeling.  
• High resolution. | • Limited instrumentation bandwidth  
• Limitations and cost of available high-voltage, high-frequency amplifiers. |
| PWP    | Pressure Wave Pulse ¹¹ | • Nondestructive.  
• Can be modeled (slightly more complex than PEA).  
• High resolution.  
• Best results with step-function pressure wave.  
• Lower voltage (<300V) required. | • PIPWP has lower probe frequency.  
• LIPP method may damage material sample.  
• Laser (LIPP) is best method for inducing step function pressure wave, but has high implementation costs. |
| LIMM   | Laser Intensity Modulation Method ¹² | • High spatial resolution.  
• No high-voltage, high-frequency amplifier required. | • Modeling more difficult.  
• Dispersion of thermal pulse limits effective probe depth.  
• May have high implementation costs. |

Referring to Table 3 and Figure 1, it is evident that spatial resolutions of ≤ 1 µm are required to satisfy both criteria (i) and (ii) to adequately resolve charge distributions for incident lower energy electrons with the highest fluxes for all but the thinnest spacecraft materials. Therefore, the targeted spatial resolution is specified at ≤ 1 µm (see Table 3).
Table 2. System Component Requirements

<table>
<thead>
<tr>
<th>Method</th>
<th>HV Supply</th>
<th>High-gain HV Amp</th>
<th>Pre-Amp</th>
<th>Function Generator</th>
<th>Waveform Digitizer</th>
<th>Ultrasonic Transducer</th>
<th>Lock-In Amp</th>
<th>Laser &amp; Driver</th>
</tr>
</thead>
<tbody>
<tr>
<td>PEA</td>
<td>X</td>
<td>X</td>
<td>X</td>
<td>X</td>
<td>X</td>
<td>Pulser</td>
<td>--</td>
<td>--</td>
</tr>
<tr>
<td>PPW</td>
<td>X</td>
<td>--</td>
<td>X</td>
<td>X</td>
<td>X</td>
<td>Receiver</td>
<td>--</td>
<td>--</td>
</tr>
<tr>
<td>LIMM</td>
<td>X</td>
<td>--</td>
<td>X</td>
<td>X</td>
<td>X</td>
<td>Receiver</td>
<td>X</td>
<td>X</td>
</tr>
</tbody>
</table>

Figure 2. Conceptual diagram showing system instrumentation components for: (a) PEA method; (b) PWP method; (c) LIMM sensor configuration (after Ref. 12).
Surface potentials in the space environment and under electron beam charging can at most reach the incident electron energy. Above ~10\(^2\) keV, the flux in even the most severe space environments is usually a fraction of lower energy fluxes (see Fig. 1).

Arcing and x-ray generation by electron guns are more problematic above ~20 kV to 50 kV.

Together, these considerations suggest a reasonable upper bound on applied voltages of ~10 kV to ~20 kV. It is wise to include the capability to monitor surface potential during sample irradiation to insure that breakdown potentials are not exceeded. The upper bound on practical applied voltages provides another motivation for higher resolution PEA; the electric fields sustainable by new extreme insulators with electrostatic breakdown field strengths of ~10\(^7\) V/m can only be realized at this applied voltage upper bound for films of ~10 \(\mu\)m thickness. [ICS O3A:4]

Space test chambers should be compatible with thin film polymeric, ceramic, or glass dielectric samples such as those listed in Table 3. Operating temperatures in space ranges from ~40 K to ~350 K (or much higher in rare, extreme cases). Ideally, the test chambers should operate at vacuums of 10\(^4\) Pa to 10\(^5\) Pa as is encountered in the space environment; at a minimum the chambers need to operate well below the Paschen discharge curve peak near 10\(^2\) Pa and below 10\(^3\) Pa to avoid reduced lifetimes for the filaments producing the electron beams for deposition.

### 2.2 Pulsed electro-acoustic (PEA) Method

Pulsed electro-acoustic (PEA) measurements are arguably the most promising method for many of the applications indentified here.\(^{14,15}\) PEA techniques generate acoustic waves within the material by applying high-voltage, high-frequency pulsed voltage probe waveforms to stimulate motion of the internal charges bound to atoms in a solid through Coulombic forces. The acoustic signal generated by the atomic displacement propagates through the material and is then converted to an electrical response signal using adjacent piezoelectric transducers.

PEA apparatus are now routinely used to measure charge distributions of density (~100 nC/cm\(^3\) or ~10\(^3\) electrons/cm\(^3\), that is ~1 nC/cm\(^2\) for ~100 \(\mu\)m thick samples) with dynamic resolution ~1 s.\(^{14,16}\) However, achieving the necessary spatial resolution for many applications involving electron beam injection has proven to be the critical problem for investigations using PEA methods over the last three decades.\(^{14,16,17}\) Initial PEA studies\(^{10,18,19,20}\) had spatial resolutions of ~100 \(\mu\)m, sufficient to study larger amplitude charge distributions in ~1 mm thick samples implanted with ~200 keV electron beams. In the subsequent three decades, improvements the basic method by Maeno\(^{10}\)—including detection electronics sensitivity and speed, better piezo-transducers, and increased ultrasonic frequencies—have led to contemporary PEA resolution of ~10 \(\mu\)m.\(^{10,21-24}\) The best systems have depth resolutions of ~4 \(\mu\)m.\(^{14,16}\) In a recent article, Arnaout et al. reviewed progress made in improving the spatial resolution of the PEA method and concluded that it was necessary to address “each part of the [PEA] cell: electrical component[s], signal treatment, choice of electrode material and sensor, etc;” including (i) the transducer/sensor/cell materials, geometry and thickness and (ii) the modeling

<table>
<thead>
<tr>
<th>Application</th>
<th>Typical Materials</th>
<th>Thickness ((\mu)m)</th>
<th>Penetration Energy(^a) (eV)</th>
<th>Conductivity(^b) ((\Omega\cdot cm))(^{-1})</th>
<th>Charge Decay Time(^c) (s)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Bulk Insulators, Optical Elements</td>
<td>SiO(_2), Al(_2)O(_3), FR4</td>
<td>10(^2)--10(^4)</td>
<td>5·10(^3)--2·10(^6)</td>
<td>10(^{14})--10(^{17})</td>
<td>10(^3)--10(^6)</td>
</tr>
<tr>
<td>Thermal Paints</td>
<td>ZnO, C</td>
<td>10(^1)--10(^3)</td>
<td>1·10(^3)--2·10(^6)</td>
<td>10(^{17})--10(^{17})</td>
<td>10(^3)--10(^6)</td>
</tr>
<tr>
<td>Solar Coverglass</td>
<td>SiO(_2), MgF, Al(_2)O(_3)</td>
<td>10(^1)--10(^2)</td>
<td>2·10(^3)--5·10(^4)</td>
<td>10(^{12})--10(^{16})</td>
<td>10(^5)--10(^6)</td>
</tr>
<tr>
<td>Thermal Blankets</td>
<td>PI, PTFE, PET</td>
<td>10(^1)--10(^2)</td>
<td>1·10(^3)--8·10(^3)</td>
<td>10(^{17})--10(^{19})</td>
<td>10(^7)--10(^8)</td>
</tr>
<tr>
<td>Composite Layers</td>
<td>Organics, Epoxy</td>
<td>10(^1)--10(^2)</td>
<td>5·10(^3)--5·10(^4)</td>
<td>10(^{14})--10(^{18})</td>
<td>10(^3)--10(^7)</td>
</tr>
<tr>
<td>Optical Coatings</td>
<td>SiO(_2), MgF</td>
<td>10(^1)--10(^3)</td>
<td>1·10(^3)--1·10(^3)</td>
<td>10(^{14})--10(^{17})</td>
<td>10(^7)--10(^8)</td>
</tr>
<tr>
<td>Contamination Layers</td>
<td>Oxides, Organics Silicone, a-C</td>
<td>10(^3)--10(^10)</td>
<td>1·10(^3)--3·10(^4)</td>
<td>10(^{12})--10(^{18})</td>
<td>10(^5)--10(^6)</td>
</tr>
</tbody>
</table>

\(^a\) Energy required for electron beam to penetrate half way through material, based on electron range models of Wilson and Dennison.\(^7\)

\(^b\) See, for example, Dennison, et al.\(^6\)

\(^c\) Based on simple planar capacitor model of materials layers, with \(\tau = \varepsilon_0/\sigma\). See, for example, Roth and Dennison.\(^7\)
of the acoustic wave generation and propagation in the complex media. This is an active area of research currently being addressed by many groups.

An important enhancement has been the development of “open PEA” or “short-circuit PEA” systems that provide direct access to thin film samples for electron beam irradiation, a significant improvement in simulating electron beam injection applications in laboratory tests. Initial open PEA systems used very thin metallic electrodes deposited on the surface, which were limited to higher energy electron beams that could penetrate the metallic electrodes. A more recent method uses a noncontact electrode placed ~1 mm above the dielectric surface, which can be swung out of the way during electron beam deposition. This has the disadvantages that signal amplitude decreases with increasing electrode-to-sample distance and the enhanced possibility of arcing from the sample to electrode, especially at elevated charge densities. Some open PEA systems are designed to operate in high vacuum, which is required for low energy studies of materials charging.

Griseri has reviewed the current status of different modified PEA apparatus with specific extended test capabilities. These include:

- Systems with high probe pulse repetition rates of 2-10 kHz capable of measuring charge profiles every 10-20 μs have been developed to study fast propagation of charge distributions through more conductive systems and charge dynamics during electrostatic breakdown. Faster high voltage amplifier electronics and waveform digitizers are the key technologies that have enabled such advanced systems.
- Systems developed particularly for use in the high voltage cable industry are capable of tests at up to 550 kV. These alternately used movable electrodes, arrays of probe or sensor electrodes, or acoustic lenses.
- Standard PEA systems in thermally controlled enclosures can operate from ~180 K to ~340 K at up to 85% humidity. Higher sample temperatures, up to ~520 K, have been achieved with additional cooling of system components.
- Semi-transparent conducting Al electrodes have been used for systems that study internal charge distributions induced by penetrating light and the subsequent in situ evolution of the charge distributions due to photoconduction. These photoconductivity studies have obvious parallels to the penetrating electron beams injections and radiation induced conductivity studies focused on in this article.

### 2.3 Pressure Wave Propagation (PWP) Method

A variation of the PEA apparatus has been developed, called "pressure wave propagation" (PWP). This method is, basically, the reverse of the PEA process. An acoustic pressure wave is generated by an ultrasonic transducer, which propagates into the charged dielectric film, and "jogs" the atomic layers and their attached charge distributions. This, in turn, causes a change in the induced charge on the electrodes on each side of the dielectric film. This change in charge (or displacement current) can be measured as a current amplified response signal. The piezoelectric-induced pressure wave pulse (PIPWP) method uses excitation with an ultrasonic (piezoelectric) transducer to generate the pressure wave. The laser-induced pressure wave propagation (LIPP) method uses a pulsed laser-induced pressure-wave created through a thermo-elastic effect to generate the pressure wave that passes through charge layer and induces a voltage (or current) across dielectric layer. An open PPW system has been developed, as a modification of the open PEA apparatus of Miyake.

One advantage of this method is that the very high-voltage (≤5 kV), high-frequency amplifiers used in the standard PEA method are not required for PWP. The high-frequency voltage waveforms needed to drive the ultrasonic sensor can be ≤100-400 V. This minimizes the possibility of an electric discharge in the chamber for measurements. The PIPWP has an inherent limit in spatial resolution due to the lower probe frequency of the ultrasonic pulser, as compared with a voltage (PEA) or light (LIMM) probe pulse. Under certain circumstances, the high intensity laser pulse needed to generate an intense enough thermal pulse for detection with LIPP can cause radiation damage in the sample. The high intensity, short-pulsed lasers used with LIPP can be costly and difficult to incorporate into a PPW system, especially an open PWP system in a vacuum chamber.
2.4 Laser Intensity Modulation Method (LIMM)

The Laser Intensity Modulation Method (LIMM) method uses a non-uniform thermal gradient in the bulk produced by irradiating the sample surface with an intensity modulated laser diode as the probe waveform. This creates a thermal wave that acts on the embedded charge, which creates a pyroelectric displacement current. This is very similar to the way the PWP pressure wave generates a displacement current due to the piezoelectric effect. The pyroelectric current depends on the laser beam modulation frequency, sensor temperature, and sample structure and physical properties; it also depends on the internal space charge and polarization of the sample. A low-noise preamplifier converts the current response signal into a voltage signal that is fed to a lock-in amplifier [see Figure 2(c)].

A low voltage signal is used with a higher current driver in the LIMM to provide the laser diode pulses. As with the PWP, no high-voltage, high-frequency amplifier is required for the LIMM. This minimizes the possibility of an electric discharge across the signal electrode or in the chamber for in vacuo measurements.\textsuperscript{12}

LIMM requires a thin electrode on the beam side of the sample (at least in present configurations), and so is not strictly an "open" method.\textsuperscript{12}

LIMM has potential for very high spatial resolution, on the order of ~1 μm, but is much more surface sensitive due to the optical/thermal excitation method. Dispersion of the thermal pulse limits the effective probe depth, thereby restricting higher resolution measurements to thin samples.\textsuperscript{18} Also, this method would tend to modify the temperature of the charged dielectric film. Detailed modeling of the propagation of the thermal pulse in the sample is required; this makes accurate modeling substantially more difficult.\textsuperscript{12}

3. SYSTEM DETAILS

We continue with a discussion of some specific system design details, including those for system components, the sample stack and piezoelectric transducers, and signal processing.

3.1 System Components

A high-voltage, low-noise DC power supply is used to apply potential across the sample to produce an electric field to drive charge transport and to polarize samples to acquire reference waveforms. As noted above, a 10 kV supply is sufficient to apply 10 MV/m field (~10% of typical breakdown field strength) across ~10\(^{-3}\) μm thick samples (see Table 3).

An arbitrary waveform generator is used to produce excitation pulses for all three methods. The pulse width needs to be much less than the transit time of the acoustic wave from the charge layer to the boundary of the dielectric film, (≤2 ns for a lower bound 10 μm thick sample). Compatibility with the high frequency ultrasonic pulses, as set by the system impedance and sample capacitance, requires a bandwidth >1 GHz, with a square wave rise time ≤2 ns. A low voltage signal is used with a driver in the LIMM to provide the laser diode pulses. For PWP methods, low voltage waveforms—on the order of 200-400 V—are needed to drive the piezoelectric ultrasonic pulser. For PEA methods, the low voltage waveform needs to be amplified using a high-frequency, high-gain, high-voltage amplifier. Output voltages up to ~5 kV are typically required to generate sufficient response signal.

Data acquisition is done with either a waveform digitizer or a digital storage oscilloscope. An acquisition rate >1 GHz is required to capture the pulsing and response signals at the >200 MHz rate of the ultrasonics. Typical waveforms have >10k pts/waveform with >8 bits amplitude resolution to capture an adequate time duration and frequency range with sufficient dynamic range. The LIMM also requires a modest quality lock-in amplifier to extract the harmonics of the input waveform from the output capacitive signal coupled through a high-gain, >1 GHz high-frequency pre-amplifier.

3.2 Sample/Sensor Stack

Figure 3 shows the arrangement of the layers comprising the sample stack in a typical PEA system. Typical PEA systems use samples [(4) in Fig. 3] with ~0.5 cm\(^{2}\) to ~5 cm\(^{2}\) surface areas and ≤0.1 nC to ≤2 nC capacitances. The high ratio of lateral to thickness dimensions allows the analysis be treated as 1D propagation in typical systems. The sample high voltage bias and capacitively-coupled lower voltage probe electrical pulse are applied to the upper surface of the sample by an upper conducting electrode [(5) in Fig. 3]. A semi-conductor film is often inserted between the upper electrode and the sample [between (4) and (5) in Fig. 3] to provide better acoustic impedance matching.
A grounded rear (lower) electrode [(3) in Fig. 3] sets the system ground and confines the electric field applied to the sample. The acoustic wave generated in the sample propagates through the sample and the lower electrode with the velocity of sound to the piezoelectric acoustic sensor [(2) in Fig. 3]. A typical 1 cm thick Al lower electrode provides ~2 µs delay, which is used to temporally separate the acoustic signal from the electrostatic noise originating with the pulse generator. An absorber [(1) in Fig. 3] is positioned under the piezoelectric sensor to dampen the acoustic signal reflected from the sensor absorber interface.

### 3.3 Ultrasonic Sensor/Transducer

The piezoelectric sensor converts the acoustic signal to an electrical signal, which is amplified by an in situ pre-amplifier. For high resolution measurements, the piezoelectric sensor needs to have a center frequency of ~200 MHz with a bandwidth >200 MHz. The resolution depends on the transmission quality at the sample. Galloy et al. identified the acoustic detector and its coupling to the surrounding elements of the sample stack as “the key of the PEA method.”

They have modeled the acoustic and electrical properties of the piezoelectric transducer using the Mason-Redwood model with an eye to improving the signal processing by better mapping the acoustic impedance matching of the system.

The most common choice for piezoelectric sensor material is polyvinylidene fluoride (PVDF). This material offers the advantage of being very broadband in its response. It is readily purchased in very thin (4 µm to 52 µm) sheets, that can be prepared in any desired shape and size. Thin metallic electrodes are typically deposited directly on the PVDF films. Currently, the highest resolutions reported are between ~5 µm and 10 µm with 9µm PVDF and ~3 µm resolution with 4 µm PVDF. In order to improve charge distribution spatial resolution to ≤1 µm, use of ~1 µm PVDF is being considered. Even though signal amplitude is reduced by using very thin PVDF films, improved resolution has been reported with PVDF sensors with 1µm thickness. Reduced signal amplitude can be compensated for by increasing the sensor sensitivity. Use of alternate polymeric nanocomposite piezoelectric sensor/actuator materials may lead to higher sensitivity and better spatial resolution. These materials exhibit higher polarization and enhanced piezoelectric behavior similar to the standard PVDF thin-film bulk materials used in most systems.

### 3.4 Signal Processing

Work by Maeno provides a detailed basis for modeling PEA experiments. Bernstein and Arnaout et al. present more recent analyses of PEA modeling. The analysis of the acoustic signal essentially use a time of flight analysis of the propagation of a complex acoustic waveform through the media. There is an extensive literature, but most models can...
be classified as ray-tracing models\textsuperscript{11,12,14,15,18,19,23,43}. That is, dominant and first arriving wavelets are individually traced through the sample and adjacent material layers in the sample holder and then mathematically summed (assuming the principal of linear superposition) to give a complete waveform that is equivalent to the measured waveform. Most literature models only account for the initial wavelet generated by the charge layer in the dielectric and ignore multiply reflecting wavelets. Waveform analysis uses the system response to a static polarization field with no induced charge to determine a system response function. The effects of the charge distribution and the response function are decoupled by binning the charge distributions in spatial regions and transforming the signals into frequency space, deconvoluting the signals, and performing an inverse Fourier transform\textsuperscript{16,54,54}. Limited filtering, including bandpass and Gaussian filters, is often used to improve the signal quality. Determination of the best methods for signal processing is an ongoing problem\textsuperscript{16,54}.

The detailed theory for the PWP method is given by Gerhard-Multhaupt\textsuperscript{45}. PWP theory is, basically, the reverse of the PEA theory. Similar signal processing issues apply.

4. CONCLUSION

Pulsed Electro-acoustic (PEA) measurements—and two closely related methods, Pressure Wave Propagation (PWP) and Laser Intensity Modulation (LIMM)—are well-established nondestructive methods to probe the spatial and temporal evolution of internal charge distributions in dielectric materials. Work is underway to improve the method to extend its range of applications for samples as thin as 10 µm with spatial resolutions of ≤1 µm, profile acquisition rates of <1 s and charge distribution sensitivities ≥100 nC/cm\textsuperscript{2} (that is, ≥0.1 nC/cm\textsuperscript{2} for ~10 µm thick samples). These capabilities—along with the ability to develop open sensor geometries, high vacuum compatibility, and a range of operating temperatures—will open the door to myriad new applications of PEA measurements, including electron beam charge deposition found in spacecraft charging and for high-energy and plasma physics apparatus. The prospect for meeting these objectives has been outlined and appears to be within reach in the near future.

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